DPE909AA

802.11abgn WiFi with BT4.0 Combo miniPCI Express



Bountec



## Perfect for WiFi and Bluetooth in one slot

## Introduction of Products

Bointec DPE909AA is a ultra solution that combines dual-band (2.4/5 GHz), 2-stream 802.11n and Bluetooth 4.0 technologies for notebooks, netbooks and tablets. The highly integrated solution not only provides customers with greater design flexibility, but can actually improve the wireless experience for consumers.

Bointec DPE909AA brings industry-leading 2x2 802.11n performance to increasingly smaller computing and CE devices. In delivers data rates of 300 Mbps and TCP throughput of more than 200 Mbps when used in 2x2 mode. It also offers a unique set of advanced 11n technologies known as Signal-Sustain Technology™ (SST), which ensures stronger wireless connections across the entire WLAN link. SST features include Low Density Parity Checking (LDPC), Transmit Beam Forming (TxBF), Maximum Ratio Combining (MRC) and Maximum Likelihood Demodulation (MLD) – which together can increase rate-over-range performance by up to 100% at short range, 50% at mid-range and 25% at long range.

Bointec DPE909AA also supports the latest Bluetooth 4.0 specification, which includes both High Speed and Low-Energy operation to extend personal area connectivity to a variety of devices.

Bointec DPE909AA also delivers superior WLAN/Bluetooth coexistence to ensure the best possible wireless experience. DPE909AA offers advanced algorithms developed to mitigate interference and takes advantage of the physical proximity of the WLAN and Bluetooth radios to provide maximum performance.

While offering superior performance and a high degree of integration, the Bointec DPE909AA also consumes lower power in every operation mode. This enables notebooks, tablets and other computing platforms to run much longer on a single battery charge.

## **Product Highlight**

- Highly integrated solution combining Atheros' dual-band, 2x2 802.11n and Bluetooth 4.0
- WLAN
  - IEEE802.11 a/b/g/n compliant 2.4GHz/5GHz
  - 2-stream 802.11n offers a maximum PHY rate of 300 Mbps
  - Conserves power with 1x1 downshift, using Dynamic MIMO Power Save
  - Supports Atheros' Signal-Sustain Technology™ (SST), which includes advanced WLAN features such as LDPC, TxBF, MLD, and STBC
- Bluetooth
  - Supports High Speed and Low Energy operation
  - Supports Enhanced Data Rate (EDR) of both 2 Mbps ( $\pi/4-$  DQPSK) and 3 Mbps (8-DPSK)
- Wake on Wireless LAN (WoW) and Wake on Bluetooth (WoBT)
- Fast Channel Switch (1 ms within band and 2 ms across bands)
- Advanced integrated coexistence features (beyond discrete chipset coexistence) to maximize combo performance
- Supports antenna sharing between Bluetooth and WLAN
- Driver offering include Linux(including Chrome OS and Android), Windows Visra,7/8/10 (32 and 64 bit), Windows XP and embedded XP
- Worldwide regulatory compliance
- Follow Atheros AR5B22 worldwide certifications.
- RoHS compliant



## Specification

WiFi Specification	
Main Chipset	Atheros® AR9462
Main Onipset	802.11a: 6, 9, 12, 18, 24, 36, 48, 54Mbps
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	802.11b: 1, 2, 5.5, 11Mbps
Transfer data rate	802.11g: 6, 9, 12, 18, 24, 36, 48, 54Mbps
	802.11n: @800Gl(400Gl)
	20MHz BW, 65(72.2) Mbps maxima, 130(130) Mbps maxima,
	40MHz BW, 135(150) Mbps maxima, 270(130) Mbps maxima,
RF connector	2 x SMT Ultra-miniature coaxial connectors (U.FL-R-SMT)
Operation mode Tx/Rx	Infrastructure & Ad-hoc mode
T x/Rx	2T2R
	• 802.11 b/g/n
	US/Canada: 11 (1 ~ 11)
Channels support	Major European country: 13 (1 ~ 13)
	France: 4 (10 ~ 13)
	Japan: 11b: 14 (1~13 or 14th), 11g: 13 (1 ~ 13)
	China: 13 (1 ~ 13)
	• 802.11 a/n
	US/Canada: 12 non-overlapping channels (36,40,44,48,52,56,60,64;
	100,104,108,112,
	64-bit, 128-bit, 152-bit WEP Encryption
Security	802.1x Authentication
	AES-CCM & TKIP Encryption
Host Interface	PCI Express® Mini Card Electromechanical Specification Revision 1.2.
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Bluetooth Specification	
Bluetooth	Bluetooth v4.0
Main Chipset	Atheros® AR9462
Frequency range	2400 ~ 2483.5MHz
Initial carrier frequency	+/- 40kHz (typical)
tolerance	
Modulation technique	Frequency hopping, 1600 hops/sec
Channel spacing	1MHz
Channels support	79 channels
Outputpower(dBm)	2dBm typical, class 2 device (-6dBm < output pow er <4dBm).
Sensitivity	-85 dBm (typ.) for pi/4-DQPSK, 0.1%BER
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Sensitivity Antenna Emission EMC certificate <u>Mechanical and Environme</u> Dimensions (W x L x H) Operating Temperature Storage Temperature Humidity	1 x SMT Ultra-miniature coaxial connectors (U.FL-R-SMT) FCC part 15 (USA) [C RSS210 (Canada) TELEC (Japan) ETSI, EN301893, EN60950 (Europe) VCCI CLASS B ant 26.65(+/-0.15mm)* 29.85(+/-0.15mm) * 3.37(+/-0.1mm) (2L FR4) -10~+60 °C
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Sensitivity Antenna Emission EMC certificate <u>Mechanical and Environme</u> Dimensions (W x L x H) Operating Temperature Storage Temperature Humidity	1 x SMT Ultra-miniature coaxial connectors (U.FL-R-SMT) FCC part 15 (USA) IC RSS210 (Canada) TELEC (Japan) ETSI, EN301893, EN60950 (Europe) VCCI CLASS B ent 26.65(+/-0.15mm)* 29.85(+/-0.15mm) * 3.37(+/-0.1mm) (2L FR4) -10-+60 °C -40-+80 °C 5~95% RH@40°C, non-condensing 3.3V +/- 9%
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Sensitivity Antenna Emission EMC certificate Dimensions (W x L x H) Operating Temperature Storage Temperature Humidity Power Management	1 x SMT Ultra-miniature coaxial connectors (U.FL-R-SMT) FCC part 15 (USA) (C RSS210 (Canada) TELEC (Japan) ETSI, EN301893, EN60950 (Europe) VCCI CLASS B ant 26.65(+/-0.15mm)* 29.85(+/-0.15mm) * 3.37(+/-0.1mm) (2L FR4) -10-+60 °C -40-+80 °C 5-95% RH@40°C, non-condensing 3.3V +/- 9% 802.11a:550mA(avg.) 802.11b: 405mA(avg.) 802.11b: 436mA(avg.) 802.11b: 436mA(avg.) 802.11n(2.4GHz): 365mA(avg.)
Sensitivity Antenna Emission EMC certificate Mechanical and Environme Dimensions (W x L x H) Operating Temperature Storage Temperature Humidity Power Management Power Requirement	1 x SMT Ultra-miniature coaxial connectors (U.FL-R-SMT) FCC part 15 (USA) (C RSS210 (Canada) TELEC (Japan) ETSI, EN301893, EN60950 (Europe) VCCI CLASS B ant 26.65(+/-0.15mm)* 29.85(+/-0.15mm) * 3.37(+/-0.1mm) (2L FR4) -10-+60 °C -40-+60 °C 5-95% RH@40°C, non-condensing 3.3V +/- 9% 802.11a:550mA(avg.) 802.11b: 405mA(avg.) 802.11b: 436mA(avg.) 802.11p: 436mA(avg.) 802.11n(2.4GHz): 365mA(avg.) 802.11n(5GHz): 445mA(avg.)
Sensitivity Antenna Emission EMC certificate Mechanical and Environme Dimensions (W x L x H) Operating Temperature Storage Temperature Humidity Power Management Power Requirement Power consumption @	1 x SMT Ultra-miniature coaxial connectors (U.FL-R-SMT) FCC part 15 (USA) (C RSS210 (Canada) TELEC (Japan) ETSI, EN301893, EN60950 (Europe) VCCI CLASS B ant 26.65(+/-0.15mm)* 29.85(+/-0.15mm) * 3.37(+/-0.1mm) (2L FR4) -10~+60 °C -40~+80 °C 5~95% RH@40°C, non-condensing 3.3V +/- 9% 802.11a:550mA(avg.) 802.11b: 405mA(avg.) 802.11b: 405mA(avg.) 802.11g: 436mA(avg.) 802.11n(2.4GHz): 365mA(avg.) 802.11n(5GHz): 445mA(avg.) Bluetooth(idle mode): 15.1mA(avg.)
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Sensitivity Antenna Emission EMC certificate Dimensions (W x L x H) Operating Temperature Storage Temperature Humidity Power Management Power Requirement Power consumption @ 25°C	1 x SMT Ultra-miniature coaxial connectors (U.FL-R-SMT) FCC part 15 (USA) (C RSS210 (Canada) TELEC (Japan) ETSI, EN301893, EN60950 (Europe) VCCI CLASS B ent 26.65(+/-0.15mm)* 29.85(+/-0.15mm) * 3.37(+/-0.1mm) (2L FR4) -10-+60 °C -40-+80 °C 5~95% RH@40°C, non-condensing 3.3V +/- 9% 802.11a:550mA(avg.) 802.11b: 405mA(avg.) 802.11b: 405mA(avg.) 802.11n(2.4GHz): 365mA(avg.) 802.11n(5GHz): 445mA(avg.) Bluetooth(idle mode): 15.1mA(avg.) Bluetooth(DH5 TX): 68.8mA(avg.)
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Sensitivity Antenna Emission EMC certificate <u>Mechanical and Environme</u> Dimensions (W x L x H) Operating Temperature Storage Temperature Humidity Power Management Power Requirement Power consumption @ 25°C Operation System	1 x SMT Ultra-miniature coaxial connectors (U.FL-R-SMT)   FCC part 15 (USA)   IC RSS210 (Canada)   TELEC (Japan)   ETSI, EN301893, EN60950 (Europe)   VCC1 CLASS B   ant   26:65(+/-0.15mm)* 29.85(+/-0.15mm) * 3.37(+/-0.1mm) (2L FR4)   -10-+60 °C   -40-+80 °C   5~95% RH@40°C, non-condensing   3.3V +/- 9%   802.11a:550mA(avg.)   802.11g: 436mA(avg.)   802.11g: 436mA(avg.)   802.11n(2.4GHz): 365mA(avg.)   802.11n(5GHz): 445mA(avg.)   Bluetooth(idle mode): 15.1mA(avg.)   Bluetooth(DH5 TX): 68.8mA(avg.)   *data are count as continuously Tx in mA   **The maximum current consum   Standard driver support : Linux / Android , Microsoft® XP, Vista, Windows 7 / 8/ 10   For specific driver for various embedded system(CPU,platform), please
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